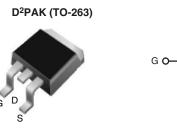


Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	200					
R _{DS(on)} (Ω)	$V_{GS} = 5 V$	0.40				
Q _g (Max.) (nC)	40					
Q _{gs} (nC)	5.5					
Q _{gd} (nC)	24					
Configuration	Single					



S N-Channel MOSFET

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- Surface Mount
- Available in Tape and Reel
- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Logic-Level Gate Drive •
- R_{DS(on)} Specified at V_{GS} = 4 V and 5 V
 150 °C Operating Temperature
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The D²PAK (TO-263) is a surface mount power package capable of accommodating die size up to HEX-4. It provides the highest power capability and the lowest possible on-resistance in any existing surface mount package. The D²PAK (TO-263) is suitable for high current applications because of its low internal connection resistance and can dissipate up to 2.0 W in a typical surface mount application.

ORDERING INFORMATION						
Package	D ² PAK (TO-263)	D ² PAK (TO-263)	D ² PAK (TO-263)			
Lead (Pb)-free and Halogen-free	SiHL630S-GE3	SiHL630STRR-GE3 ^a	SiHL630STRL-GE3ª			
Load (Pb) free	IRL630SPbF	IRL630STRRPbF ^a	IRL630STRLPbF ^a			
Lead (Pb)-free	SiHL630S-E3	SiHL630STR-E3 ^a	SiHL630STL-E3ª			

Note

a. See device orientation.

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage	V _{DS}	200	V		
Gate-Source Voltage	V _{GS}	± 10	v		
Continuous Drain Current	Ver at 5 V	T _C = 25 °C	ID	9.0	
Continuous Drain Current	V _{GS} at 5 V	T _C = 25 °C T _C = 100 °C		5.7	A
Pulsed Drain Current ^a			I _{DM}	36	
Linear Derating Factor				0.59	W/°C
Linear Derating Factor (PCB Mount) ^e			0.025	VV/C	
Single Pulse Avalanche Energy ^b		E _{AS}	250	mJ	
Avalanche Current ^a			I _{AR}	9.0	A
Repetiitive Avalanche Energy ^a			E _{AR}	7.4	mJ
Maximum Power Dissipation	25 °C	Р	74	w	
Maximum Power Dissipation (PCB Mount) ^e	P _D	3.1	vv		
Peak Diode Recovery dV/dtc		dV/dt	5.0	V/ns	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to + 150	- °C		
Soldering Recommendations (Peak Temperature)	10 s	-	300 ^d		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. V_{DD} = 25V, starting T_J = 25 °C, L = 4.6 mH, R_g = 25 Ω , I_{AS} = 9.0 A (see fig. 12).

c. $I_{SD} \le 9.0$ A, dI/dt ≤ 120 A/µs, $V_{DD} \le V_{DS}$, $T_{J} \le 150$ °C.

d. 1.6 mm from case.

e. When mounted on 1" square PCB (FR-4 or G-10 material).

* Pb containing terminations are not RoHS compliant, exemptions may apply

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COMPLIANT

HALOGEN FREE

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THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	TYP.	MAX.	UNIT			
Maximum Junction-to-Ambient	R _{thJA}	-	62				
Maximum Junction-to-Ambient (PCB Mount) ^a	R _{thJA}	-	40	°C/W			
Maximum Junction-to-Case (Drain)	R _{thJC}	-	1.7				

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL TEST CONDITIONS			MIN.	TYP.	MAX.	UNIT
Static					•	•	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS}	= 0, I _D = 250 μA	200	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference	Reference to 25 °C, $I_D = 1 \text{ mA}$			-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	1.0	-	2.0	V	
Gate-Source Leakage	I _{GSS}		-	-	± 100	nA	
Zana Oata Maltana Dusia Orimont		$V_{DS} = 200 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	25	
zero Gate voltage Drain Current	Cate Voltage Drain Current I_{DSS} $V_{DS} = 160 V, V_{GS} = 0 V, T_J = 125 °C$		∕, V _{GS} = 0 V, T _J = 125 °C	-	-	250	μA
Drain-Source On-State Resistance	D	$V_{GS} = 5.0 V$	I _D = 5.4 A ^b	-	-	0.40	Q
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 4.0 V$	$I_D = 4.5 \text{ A}^{b}$	-	-	0.50	52
Forward Transconductance	g fs	V _{DS} =	= 50 V, I _D = 5.4 A ^b	4.8	-	-	S
Dynamic		·					
Input Capacitance	C _{iss}		$V_{GS} = 0 V$,	-	1100	-	
Output Capacitance	C _{oss}		$V_{DS} = 25 V,$	-	220	-	pF
Reverse Transfer Capacitance	C _{rss}	f = 1.	.0 MHz, see fig. 5	-	70	-	1
Total Gate Charge	Qg			-	-	40	nC
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	I _D = 9.0 A, V _{DS} = 160 V, see fig. 6 and 13 ^b	-	-	5.5	
Gate-Drain Charge	Q _{gd}	1		-	-	24	
Turn-On Delay Time	t _{d(on)}			-	8.0	-	- ns
Rise Time	t _r	V _{DD} =	100 V, I _D = 9.0 A,	-	57	-	
Turn-Off Delay Time	t _{d(off)}	$R_g = 6.0 \Omega$,	$R_D = 11 \Omega$, see fig. 10^{b}	-	38	-	
Fall Time	t _f			-	33	-	
Internal Drain Inductance	L _D	Between lead 6 mm (0.25") 1	, 	-	4.5	-	
Internal Source Inductance	L _S	package and die contact	package and center of			-	- nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the		-	-	9.0	A
Pulsed Diode Forward Current ^a	I _{SM}	integral revers p - n junction		-	-	36	
Body Diode Voltage	V_{SD}	T _J = 25 °C	$I_{\rm S} = 9.0 \text{ A}, V_{\rm GS} = 0 \text{ V}^{\rm b}$	-	-	2.0	V
Body Diode Reverse Recovery Time	t _{rr}	T 05 00 1	= 9.0 A, dl/dt = 100 A/µs ^b	-	230	350	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$I_{\rm J} = 25 {}^{\circ}{\rm C}, I_{\rm F}$	-	1.7	2.6	μC	
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L_S and L_D)					

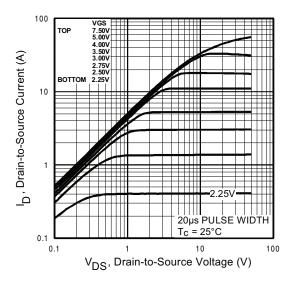
Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Fig. 1 - Typical Output Characteristics, T_C = 25 °C

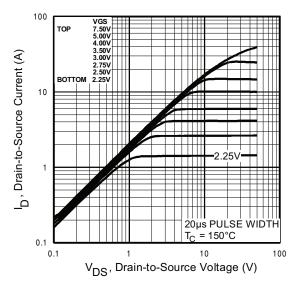
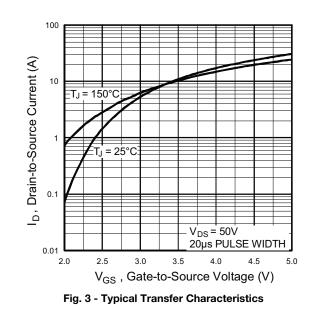


Fig. 2 - Typical Output Characteristics, T_C = 150 °C



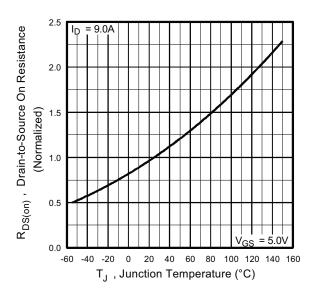


Fig. 4 - Normalized On-Resistance vs. Temperature

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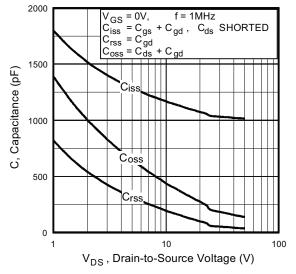


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

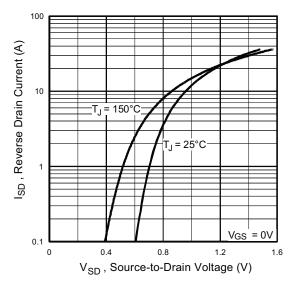


Fig. 7 - Typical Source-Drain Diode Forward Voltage

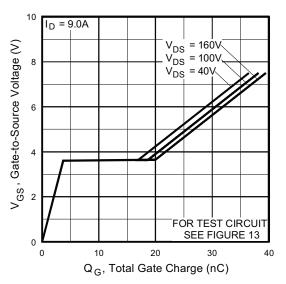


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

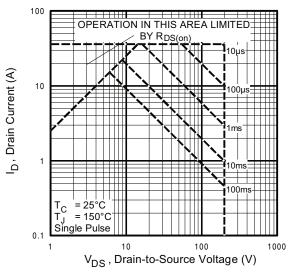


Fig. 8 - Maximum Safe Operating Area

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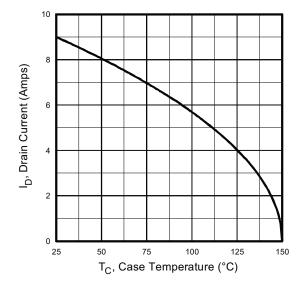


Fig. 9 - Maximum Drain Current vs. Case Temperature

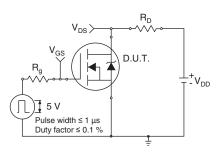


Fig. 10a - Switching Time Test Circuit

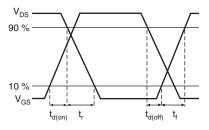


Fig. 10b - Switching Time Waveforms

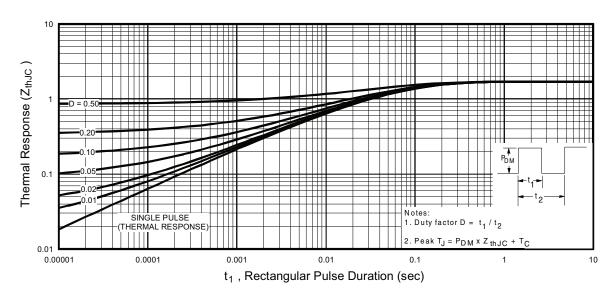


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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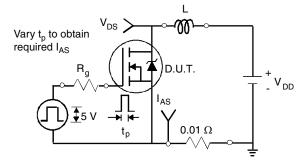


Fig. 12a - Unclamped Inductive Test Circuit

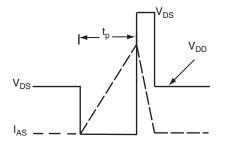


Fig. 12b - Unclamped Inductive Waveforms

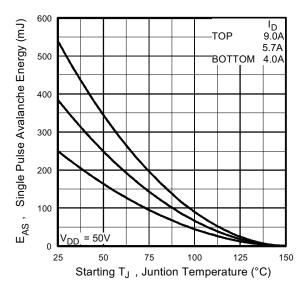
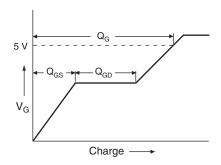


Fig. 12c - Maximum Avalanche Energy vs. Drain Current





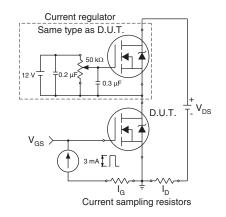
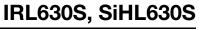


Fig. 13b - Gate Charge Test Circuit

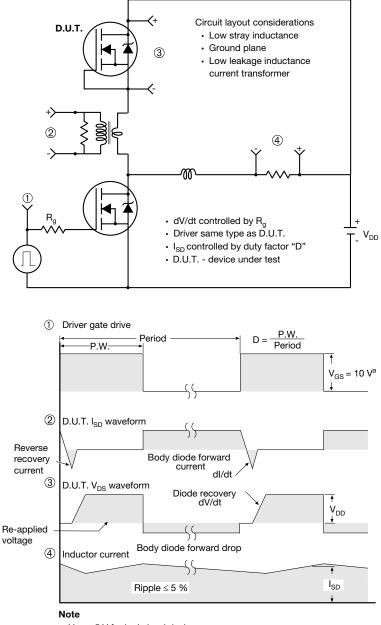
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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel

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H

A1

B

Gauge plane

L3

Detail "A" Rotated 90° CW scale 8:1

0° to 8° **Vishay Siliconix**

Seating plane

TO-263AB (HIGH VOLTAGE)

/3 ⁄4 A

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∕₅∖

Detail A

(Datum A)

D

 $\underline{4}$ 11

	2	-	Y 2 x b2 2 x b ⊕ 0.010 @ A(■ ating 5 b1, b b1, b b1, b c) c) c) c) c) c) c) c) c) c)	$\begin{array}{c} c_{1} \\ c_{1} \\ c_{2} \\ c_{3} \\ c_{4} \\ c_{5} \\ c_{5} \\ c_{7} \\$	a - 1		Ū.	1 <u>4</u>	
	MILLIN	IETERS	INCHES				MILLIMETERS		INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.		DIM.	MIN.	MAX.	MIN.	MAX.
А	4.06	4.83	0.160	0.190		D1	6.86	-	0.270	-
				0.010		-		10.07	0.000	0.420
A1	0.00	0.25	0.000	0.010		E	9.65	10.67	0.380	0.120
A1 b	0.00 0.51	0.25 0.99	0.000	0.010		E1	9.65 6.22	- 10.67	0.380	-
							6.22	- 10.67 - BSC	0.245	- BSC
b	0.51	0.99	0.020	0.039		E1	6.22	-	0.245	-
b b1	0.51 0.51	0.99 0.89	0.020 0.020	0.039 0.035		E1 e	6.22 2.54	- BSC	0.245	-) BSC
b b1 b2	0.51 0.51 1.14	0.99 0.89 1.78	0.020 0.020 0.045	0.039 0.035 0.070		E1 e H	6.22 2.54 14.61	- BSC 15.88	0.245 0.100 0.575	-) BSC 0.625
b b1 b2 b3	0.51 0.51 1.14 1.14	0.99 0.89 1.78 1.73	0.020 0.020 0.045 0.045	0.039 0.035 0.070 0.068		E1 e H L	6.22 2.54 14.61 1.78	- BSC 15.88 2.79	0.245 0.100 0.575 0.070	- 0 BSC 0.625 0.110
b b1 b2 b3 c	0.51 0.51 1.14 1.14 0.38	0.99 0.89 1.78 1.73 0.74	0.020 0.020 0.045 0.045 0.015	0.039 0.035 0.070 0.068 0.029		E1 e H L L1	6.22 2.54 14.61 1.78 - -	- BSC 15.88 2.79 1.65	0.245 0.100 0.575 0.070 - -	- 0 BSC 0.625 0.110 0.066
b b1 b2 b3 c c1	0.51 0.51 1.14 1.14 0.38 0.38	0.99 0.89 1.78 1.73 0.74 0.58	0.020 0.020 0.045 0.045 0.015 0.015	0.039 0.035 0.070 0.068 0.029 0.023		E1 e H L L1 L2	6.22 2.54 14.61 1.78 - -	- BSC 15.88 2.79 1.65 1.78	0.245 0.100 0.575 0.070 - -	- 0 BSC 0.625 0.110 0.066 0.070

Α

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Dimensions are shown in millimeters (inches).

3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.

4. Thermal PAD contour optional within dimension E, L1, D1 and E1.

5. Dimension b1 and c1 apply to base metal only.

6. Datum A and B to be determined at datum plane H.

7. Outline conforms to JEDEC outline to TO-263AB.



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